

1. Features

- Low EMI noise and small footprint (5.75mm²) using inductor-embedded ferrite substrate
- Up to 90% high efficiency using synchronous rectifier technology at 6MHz operation
- PFM/PWM automatic mode switching function for high efficiency operation over full current range
- PWM forced mode for low ripple noise operation
- Wide input voltage range : 2.7~5.5V
- Maximum Load Current: 600mA.
- Fixed output voltage: 1.2V, 1.5V, 1.8V, 3.0V, 3.3V
- Internal soft start, 120 µs start-up time
- Current over load and thermal shutdown protection



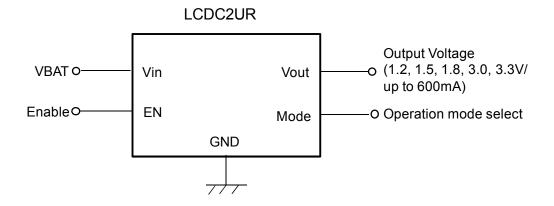
2. Description

The LXDC2UR series is a low power step-down DC-DC converter, which is suitable for a space-limited or a noise-sensitive application. The device utilizes an inductor-embedded ferrite substrate, and the substrate eliminates radiated EMI noise and conduction noise efficiently.

By just putting this device, it can be used as a high performance LDO replacement. Its low noise feature and easy to assembly feature assures reliable power supply quality.

The device works in PFM mode at light load and it extends the battery life by reducing quiescent current. At heavy load, its control mode changes to PWM mode automatically and it keeps high efficiency using synchronous rectifying technology. If only heavy load current operation is needed, PWM forced mode is available. In PWM forced mode, ripple noise is reduced. In shutdown mode, the current consumption is up to 1uA.

3. Typical Application Circuit

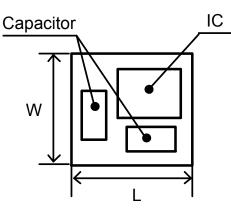




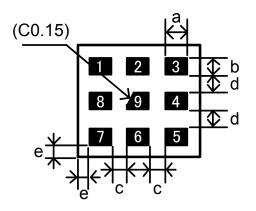
4. Mechanical details

4-1 Outline

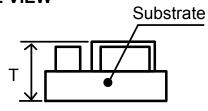
TOP VIEW



BOTTOM VIEW



SIDE VIEW



Unit: mm

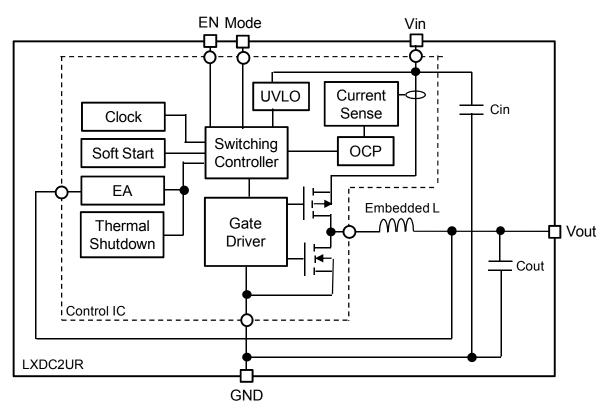
| Mark | Dimension | |
|------|---------------|--|
| L | 2.5 +/- 0.2 | |
| W | 2.3 +/- 0.2 | |
| Т | 1.2 MAX | |
| а | 0.45 +/- 0.1 | |
| b | 0.35 +/- 0.1 | |
| С | 0.325 +/- 0.1 | |
| d | 0.375 +/- 0.1 | |
| е | 0.25 +/- 0.2 | |



4-2. Pin Function

| Pin | Symbol | I/O | Description | |
|-------|--------|--------|--|--|
| 1 | Mode | Input | This is the operation mode select pin. This pin must not be lef floating and must be terminated. Mode=H: Low-noise mode enabled, fixed frequency PWM operation is forced. Mode=L: This device is operating in pulse frequency modulati mode (PFM) at light load currents, and in regulated frequency pulse width mode (PWM) at high-load currents. | |
| 2,6,9 | GND | - | Ground pin | |
| 3,4 | Vout | Output | Regulated voltage output pin. Apply output load between this pin and GND. | |
| 5 | EN | Input | This is the ON/OFF control pin of the device. Connecting this pin to GND keeps the device in shutdown mode. Pulling this pin to Vin enables the device with soft start. This pin must not be left floating and must be terminated. EN=H: Device ON, EN=L: Device OFF | |
| 7,8 | Vin | Input | Vin pin supplies current to the LXDC2UR internal regulator. | |

4-3. Functional Block Diagram





5. Ordering Information

| Part number | Output Voltage | Device Specific Feature | MOQ |
|----------------|----------------|-------------------------|----------------|
| LXDC2UR12A-118 | 1.2V | Standard Type | T/R, 3000pcs/R |
| LXDC2UR15A-119 | 1.5V | Standard Type | T/R, 3000pcs/R |
| LXDC2UR18A-120 | 1.8V | Standard Type | T/R, 3000pcs/R |
| LXDC2UR30A-143 | 3.0V | Standard Type | T/R, 3000pcs/R |
| LXDC2UR33A-122 | 3.3V | Standard Type | T/R, 3000pcs/R |

6. Electrical Specification

6-1 Absolute maximum ratings

| Parameter | symbol | rating | Unit |
|--------------------------|--|------------|------|
| Input voltage | Vin, EN, Mode 6.3 | | V |
| Operating temperature | Та | -40 to +85 | °C |
| Operating IC temperature | emperature T _{IC} -40 to +125 | | °C |
| Storage temperature | T _{STO} | -40 to +85 | °C |



6-2 Electrical characteristics (Ta=25°C)

| Parameter | Symbol | C | ondition | Min. | Тур. | Max. | Unit |
|-----------------------------|--|--------------------------|----------------|-------|------|-------|------|
| Input voltage | V _{in} | Vout ≦1.8V | Vout ≦1.8V | | - | 5.5 | v |
| input voltage | V in | Vout ≧3.0V | | 3.6 | - | 5.5 | v |
| UVLO voltage | UVLO | | | - | 2.05 | 2.1 | V |
| Input leak current | lin-off | Vin=3.6V, EN=Mode=0V | | - | 0.1 | 2 | uA |
| | | | LXDC2UR12A-118 | | | | |
| | | Vin=EN=3.6V, Mode=0V | LXDC2UR15A-119 | - | 37 | 60 | |
| Operating quiescent current | lin-on | | LXDC2UR18A-120 | | | | uA |
| ourion | | Vin=EN=5.0V | LXDC2UR30A-143 | | 60 | 90 | |
| | | Mode=0V | LXDC2UR33A-122 | - | 60 | 80 | |
| | | | LXDC2UR12A-118 | 1.176 | 1.20 | 1.224 | |
| | Vout | Vin-Vout>0.6V | LXDC2UR15A-119 | 1.47 | 1.50 | 1.53 | V |
| Output voltage accuracy | | | LXDC2UR18A-120 | 1.764 | 1.80 | 1.836 | |
| accuracy | | | LXDC2UR30A-143 | 2.94 | 3.00 | 3.06 | |
| | | | LXDC2UR33A-122 | 3.234 | 3.30 | 3.366 | |
| Load current range | lout | | | 0 | | 600 | mA |
| | | Vin=3.6V, | LXDC2UR12A-118 | | 15 | | |
| | | lout=300mA, | LXDC2UR15A-119 | | | | |
| | | BW=100MHz | LXDC2UR18A-120 | | | | |
| Ripple voltage | Vrpl | DW - 10010112 | LXDC2UR30A-143 | - | | | mV |
| | | Vin=5.0V, Iout=300mA, | LXDC2UR33A-122 | | | | |
| | | BW=100MHz | | | | | |
| | | | LXDC2UR12A-118 | | 82 | - | |
| | | Vin=3.6V, | LXDC2UR15A-119 | | 85 | - | % |
| Efficiency | EFF Iout=300mA Vin=5.0V, Iout=300A | | LXDC2UR18A-120 | | 86 | - | |
| | | | LXDC2UR30A-143 | | 93 | - | /0 |
| | | | LXDC2UR33A-122 | | 91 | - | |



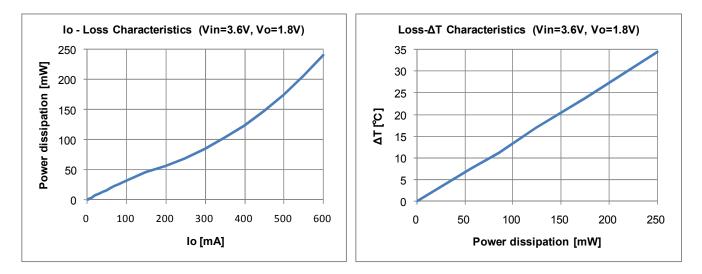
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
|-------------------------|--------|-----------------------------|------|----------|------|------|
| EN control voltage | VENH | H ON; Enable | | - | Vin | v |
| EN control voltage | VENL | OFF; Disable | 0 | - | 0.4 | V |
| Mada control voltage | VMODH | High; PWM forced mode | 1.4 | - | Vin | v |
| Mode control voltage | VMODL | Low; Automatic PFM/PWM mode | 0 | - | 0.4 | V |
| SW Frequency | Fosc | lout=300mA, PWM mode | 5.0 | 6.0 | 7.0 | MHz |
| | | LXDC2UR12A-118 | | | | |
| | Rds | LXDC2UR15A-119 | | 15 | | |
| Discharge resistor | | LXDC2UR18A-120 | | | | Ω |
| | | LXDC2UR30A-143 | | 110 | | |
| | | LXDC2UR33A-122 | | 110 | | |
| | | LXDC2UR12A-118 | | | | |
| | | LXDC2UR15A-119 | 600 | 900 | 1200 | |
| Over current protection | OCP | LXDC2UR18A-120 | | | | mA |
| | | LXDC2UR30A-143 | 600 | 4000 | 1800 | |
| | | LXDC2UR33A-122 | 600 | 600 1200 | | |
| Start-up time | Ton | | | 120 | | μs |

(*)The above characteristics are tested using the test circuit on section 8.



6-3 Thermal and Current De-rating Information

The following figure shows the power dissipation and temperature rise characteristics example. These data are measured on Murata's evaluation board of this device at no air-flow condition.

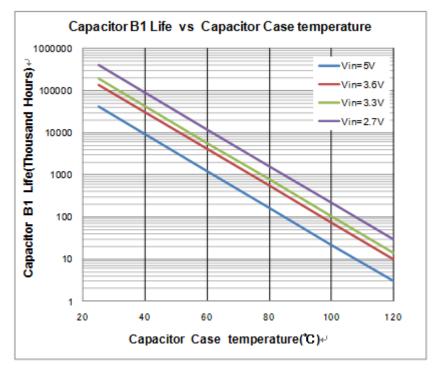


The output current of the device may need to be de-rated if it is operated in a high ambient temperature or in a continuous power delivering application. The amount of current de-rating is highly dependent on the environmental thermal conditions, i.e. PCB design, nearby components or effective air flows. Care should especially be taken in applications where the device temperature exceeds 85°C.

The IC temperature of the device must be kept lower than the maximum rating of 125 °C. It is generally recommended to take an appropriate de-rating to IC temperature for a reliable operation. A general de-rating for the temperature of semiconductor is 80%.

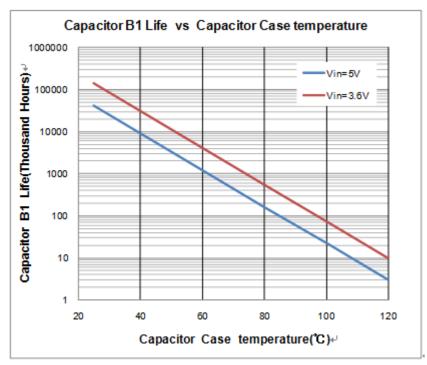
MLCC capacitor's reliability and lifetime are also depending on temperature and applied voltage stress. Higher temperature and/or higher voltage cause shorter lifetime of MLCC, and the degradation can be described by the Arrhenius model. The most critical parameter of the degradation is IR (Insulation Resistance). The below figure shows MLCC's B1 life based on a failure rate reaching 1%. It should be noted that wear-out mechanisms in MLCC capacitor is not reversible but cumulative over time.





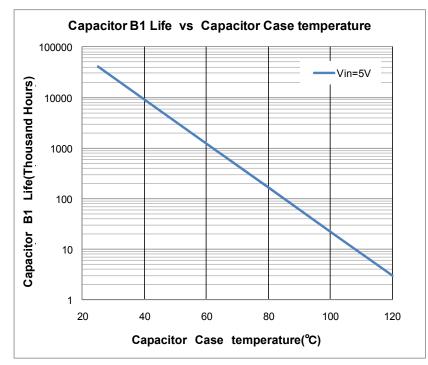
• LXDC2UR12A-118, LXDC2UR15A-119, LXDC2UR18A-120

• LXDC2UR30A-143





•LXDC2UR33A-122



The following steps should be taken before the design fix of user's set for a reliable operation.

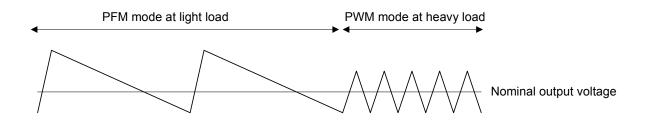
- 1. The ambient temperature of the device should be kept below $85 \,^{\circ}$ C
- 2. The IC temperature should be measured on the worst condition of each application. The temperature must be kept below 125 °C. An appropriate de-rating of temperature and/or output current should be taken.
- 3. The MLCC temperature should be measured on the worst condition of each application. Considering the above figure, it should be checked if the expected B1 life of MLCC is acceptable or not.



7. Detailed Description

Mode selection

The MODE pin allows selecting the operating mode. If the MODE pin is pulled to logic low voltage (VMODL), the converter operates automatic PFM and PWM mode. In this mode, the converter operates PFM mode at light load current, and when the load current increase, the operating mode will change to PWM mode automatically. In this mode, the converter can work in high efficiency over wide load current range. The transition current between PFM and PWM is depend on Vin, Vout and other factors, but the ballpark threshold is about 70-150mA If the MODE pin is pulled to logic high voltage (VMODH), the device operates in PWM forced mode. In this mode, the converter operates in PWM mode even at light load current. The advantage of this mode is that the converter operates with a fixed frequency that allows simple filtering of switching frequency. In this mode, the efficiency is lower compared to the PFM mode at light load current.



UVLO (Under Voltage Lock Out)

The input voltage (Vin) must reach or exceed the UVLO voltage (2.05Vtyp) before the device begins the start up sequence even when EN pin is kept high. UVLO function keeps away of an unstable operation at low Vin range

Soft Start

The device has an internal soft-start function that limits the inrush current during start-up. The soft-start system progressively increases the switching on-time from a minimum pulse-width to that of normal operation. Because of the function, the output voltage increases gradually from zero to nominal voltage at start-up event. The nominal soft-start time is 120 µsec.

Enable

The device starts operation when EN is set high and starts up with soft start. For proper operation, the EN pin must be terminated to logic high and must not left floating.

Pulling the EN pin to logic low forces the device shutdown. The shutdown quiescent current is 0.1 μ A (typ).

Discharge Function

LXDC2UR series can actively discharge the internal output capacitor (Cout) when it turns off. The discharge time depends on external output capacitance. LXDC2UR series do not need external capacitors, but if you use external output capacitor its discharge time will become longer.

Over Current Protection

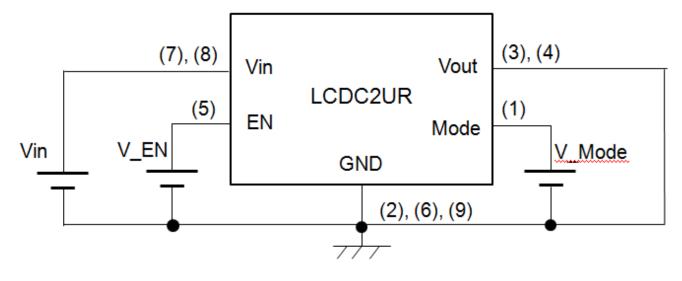
LXDC2UR series integrates a current limit function to protect internal components against heavy load or short circuits. When over current event is removed, the device returns to the normal operation automatically.

Thermal Shutdown

As soon as the internal IC's junction temperature exceeds 140° C (typ), the device goes into thermal shutdown. The device returns to its normal operation when the Internal IC's junction temperature again falls below 130° C(typ).



8. Test Circuit





9.Reliability Tests

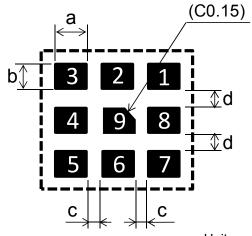
| No. | lte | ms | Specifications | Test Methods | QTY | Result (NG) |
|-----|---|--|--|--|-----|----------------|
| 1 | Vibration Resistance | iron or reflow and be conducted with care so that the soldering is uniform and free of defect such as by heat shock. Frequency : 10~2000 Hz Acceleration : 196 m/s ² Direction : X,Y,Z 3 axis Period : 2 h on each direction | | (glass fluorine boards) shown in appended Fig.1 by a Pb free solder. The soldering shall be done either by iron or reflow and be conducted with care so that the soldering is uniform and free of defect such as by heat shock. Frequency : 10~2000 Hz Acceleration : 196 m/s ² Direction : X,Y,Z 3 axis | 18 | G (0) |
| 2 | Deflection | | | Solder specimens on the testing jig (glass epoxy boards) shown in appended Fig.2 by a Pb free solder. The soldering shall be done either by iron or reflow and be conducted with care so that the soldering is uniform and free of defect such as by heat shock. Deflection : 1.6mm | 18 | G (0) |
| 3 | Soldering streng (Push Strength) | th | 9.8 N Minimum | Solder specimens onto test jig shown below. Apply pushing force at 0.5mm/s until electrode pads are peeled off or ceramics are broken. Pushing force is applied to longitudinal direction. Pushing Direction Specimen Jig | 18 | G (0) |
| 4 | Solderability of Termination | | 75% of the terminations is to be soldered evenly and continuously. | Immerse specimens first an ethanol solution of rosin, then in a Pb free solder solution for 3±0.5 sec. at 245±5 °C. Preheat : 150 °C, 60 sec. Solder Paste : Sn-3.0Ag-0.5Cu Flux : Solution of ethanol and rosin (25 % rosin in weight proportion) | 18 | G (0) |
| 5 | Resistance to Soldering Heat (Reflow) | Appearance Electrical specifications | No severe damages Satisfy specifications listed in paragraph 6-2. | Preheat Temperature : 150-180 °C Preheat Period : 90+/-30 sec. High Temperature : 220 °C High Temp. Period : 20sec. Peak Temperature : 260+5/-0 °C Specimens are soldered twice with the above condition, and then kept in room condition for 24 h before measurements. | 18 | G (0) |



| No. | Items | | Specifications | Test Met | thods | | QTY | Result (NG) |
|-----|----------------------------|---------------------------|---|---|---------------------------------|------------------|----------|----------------|
| 6 | High Temp. Exposure | | Temperature:85±2 °C Period:1000+48/-0 h Room Condition:2~24h | | 18 | G (0) | | |
| 7 | Temperature Cycle | | | Conditio table | n:100 cycles | in the following | 9 | |
| | | | | Step | Temp(°C) | Time(min) | | |
| | | | | 1 | Min. Operating Temp.+0/-3 | 30±3 | 18 | G (0) |
| | | Appearance | No severe damages | 2 | Max. Operating Temp.+3/-0 | 30±3 | | |
| 8 | Humidity (Steady State) | Electrical specifications | Satisfy specifications listed in paragraph 6-2. | Temperature : 85±2 °C Humidity : 80~90%RH Period : 1000+48/-0 h Room Condition : 2~24h | | 18 | G (0) | |
| 9 | Low Temp. Exposure | - | | Temperature : -40±2 °C Period : 1000+48/-0 h Room Condition : 2~24h | | 18 | G (0) | |
| 10 | ESD(Machine Model) | | C:200pF, R:0Ω TEST Voltage :+/-100V Number of electric discharges:1 | | 5 | G (0) | | |
| 11 | ESD(Human Body Model) | | | C:100pF、R:1500Ω TEST Voltage :+/-1000V Number of electric discharges:1 | | 5 | G (0) | |



Fig.1 Land Pattern



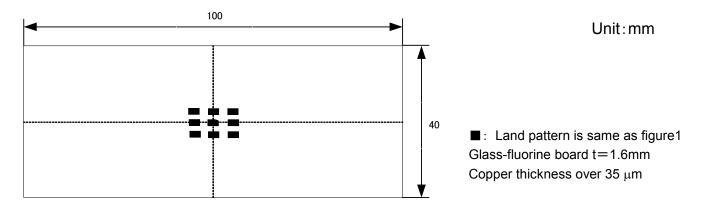
Unit: mm

| Mark | Dimension |
|------|-----------|
| а | 0.45 |
| b | 0.35 |
| с | 0.325 |
| d | 0.375 |

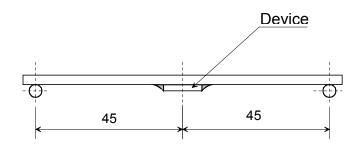
•Reference purpose only.



Fig.2 Testing board

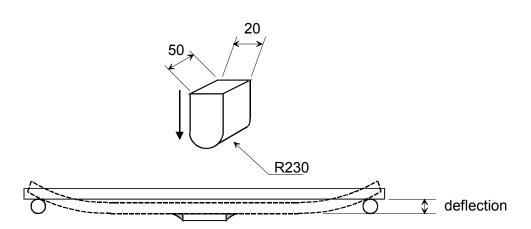


Mounted situation



Unit:mm

Test method



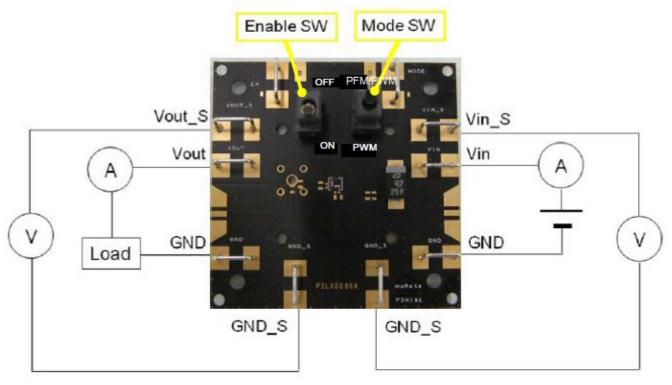
Unit:mm



10. Measurement Data

Micro DC-DC Converter evaluation board (P2LX0006A)

Measurement setup



The enable switch has three states (ON, OFF and Open).

- 1. When it is toggled to "ON" side, the device starts operation.
- 2. When it is toggled to "OFF" side, the device stop operation and keep shut down status.
- 3. When it is set to open, the EN pin floats and an external voltage can be applied to the EN terminal pin on the EVB. If you don't apply an external voltage to EN pin, the enable switch should not to be set to the middle position.

The mode switch has three states (PWM, PFM/PWM and Open).

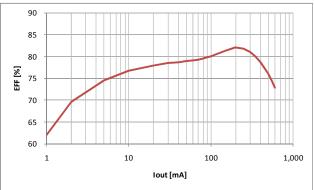
- 1. When it is toggled to "PWM" side, the device operates PWM forced mode.
- 2. When it is toggled to "PFM/PWM" side, the device operates PFM/PWM automatic mode.
- 3. When it is set to open, the mode pin floats and an external voltage can be applied to the Mode terminal pin on the EVB. If you don't apply an external voltage to Mode pin, the mode switch should not to be set to the middle position.

%The 47uF capacitor is for the evaluation kit only, and has been added to compensate for the long test cables.

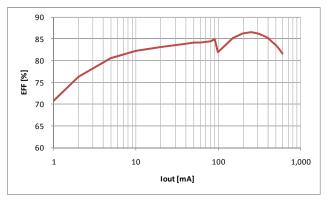


Efficiency

• Vin=3.6V, Vout=1.2V



• Vin=3.6V, Vout=1.8V

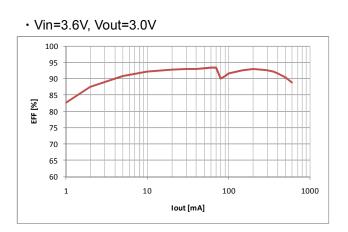


• Vin=5.0V, Vout=3.3V



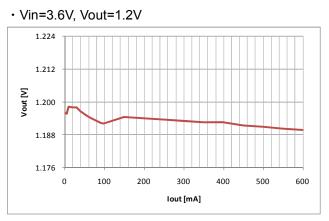
Vin=3.6V, Vout=1.5V

 ⁹⁰
 ⁹

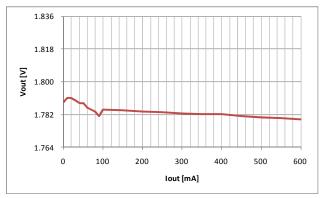




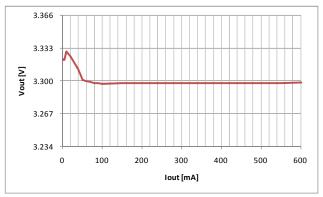
Load Regulation

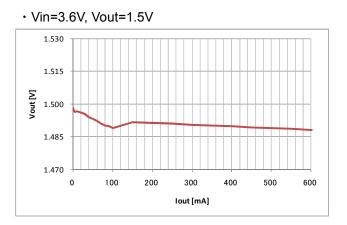


· Vin=3.6V, Vout=1.8V

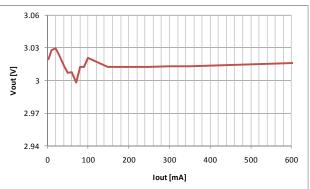


· Vin=5.0V, Vout=3.3V



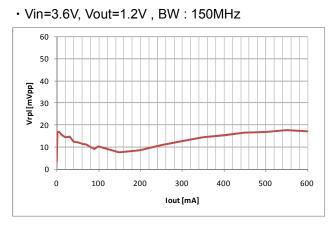


• Vin=3.6V, Vout=3.0V

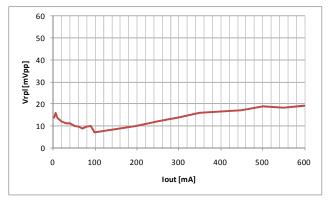




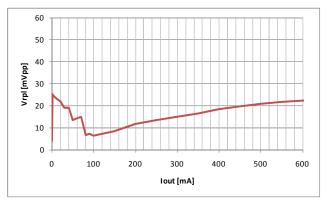
Output Ripple-Noise

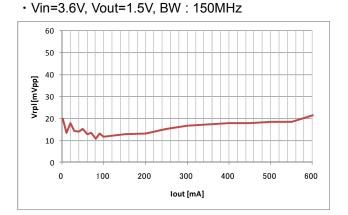


· Vin=3.6V, Vout=1.8V, BW : 150MHz

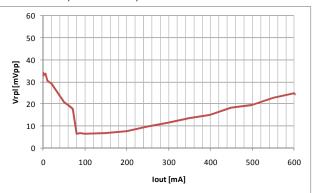


• Vin=5.0V, Vout=3.3V, BW : 150MHz





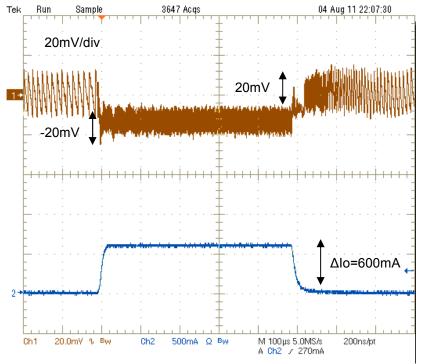
• Vin=3.6V, Vout=3.0V, BW : 150MHz



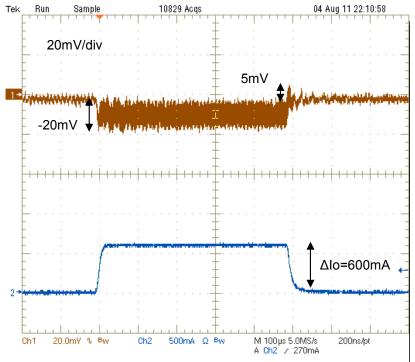


Load Transient Response

· Vin=3.6V, Vout=1.2V, Mode : PFM/PWM



Vin=3.6V, Vout=1.2V, Mode : PWM forced

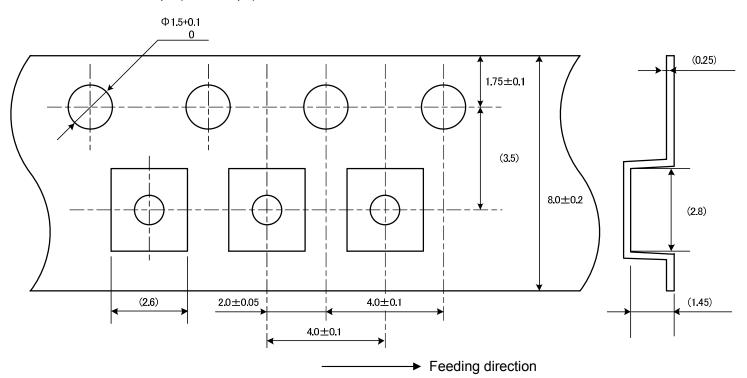




11. Tape and Reel Packing

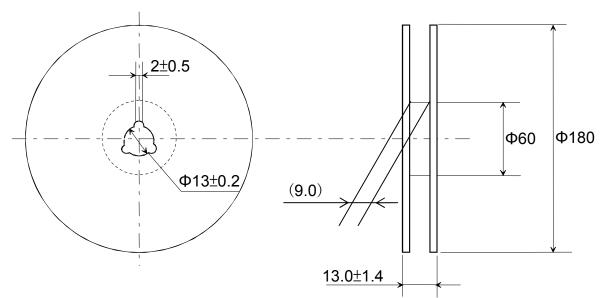
1) Dimensions of Tape (Plastic tape)





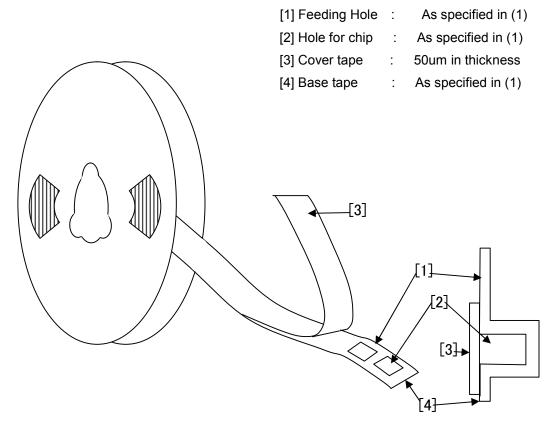
2) Dimensions of Reel

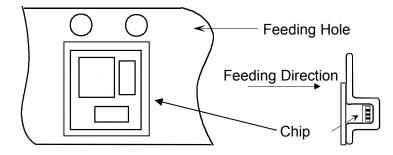
Unit: mm





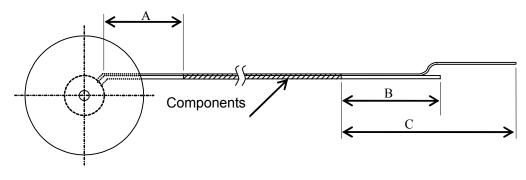
3) Taping Diagrams





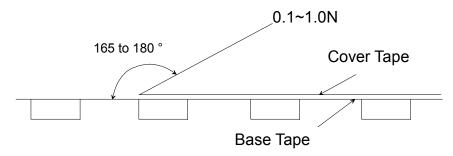


4) Leader and Tail tape



| Symbol | Items | Ratings(mm) |
|--------|--------------------------|-------------|
| А | No components at trailer | min 160 |
| В | No components at leader | min 100 |
| С | Whole leader | min 400 |

- 5) The tape for chips are wound clockwise, the feeding holes to the right side as the tape is pulled toward the user.
- 6) Packaging unit: 3,000 pcs./ reel
- 7) Material: Base Tape ... Plastic
 Reel ... Plastic
 Antistatic coating for both base tape and reel
- 8) Peeling of force





NOTICE

1. Storage Conditions:

To avoid damaging the solderability of the external electrodes, be sure to observe the following points.

- Store products where the ambient temperature is 15 to 35 °C and humidity 45 to 75% RH.
- (Packing materials, In particular, may be deformed at the temperature over 40 °C.).
- Store products in non corrosive gas (Cl₂, NH₃,SO₂, No_x, etc.).
- Stored products should be used within 6 months of receipt. Solderability should be verified if this period is exceeded

This product is applicable to MSL1 (Based on IPC/JEDEC J-STD-020).

2. Handling Conditions:

Be careful in handling or transporting the product. Excessive stress or mechanical shock may damage the product because of the nature of ceramics structure.

Do not touch the product, especially the terminals, with b<u>are ear hands. Doing so that</u> may result in poor solderability.

3. Standard PCB Design (Land Pattern and Dimensions):

- All the ground terminals should be connected to the ground patterns. Furthermore, the ground pattern should be provided between IN and OUT terminals. Please refer to the specifications for the standard land dimensions.
- The recommended land pattern and dimensions are shown for a reference puerpose only.
- Electrical, mechanical and thermal characteristics of the product shall depend on the pattern design and material / thickness of the PCB. Therefore, be sure to check the product performance in the actual set. When using underfill materials, be sure to check the mechanical characteristics in the actual set.

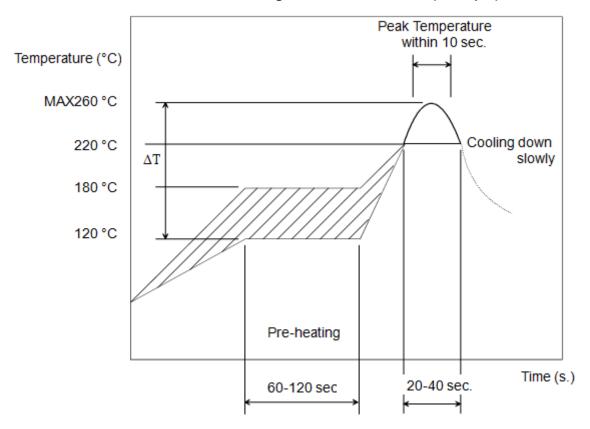


4. Soldering Conditions:

Soldering is allowed up through 2 times.

Carefully perform preheating $\therefore \Delta T$ less than 130 °C.

When products are immersed in solvent after mounting, pay special attention to maintain the temperature difference within 100 °C. Soldering must be carried out by the above mentioned conditions to prevent products from damage. Contact Murata before use if concerning other soldering conditions.



Reflow soldering standard conditions (example)

Use rosin type flux or weakly active flux with a chlorine content of 0.2 wt % or less.



5. Cleaning Conditions:

The product is not designed to be cleaned after soldering.

6. Operational Environment Conditions:

Products are designed to work for electronic products under normal environmental conditions (ambient temperature, humidity and pressure). Therefore, products have no problems to be used under the similar conditions to the above-mentioned. However, if products are used under the following circumstances, it may damage products and leakage of electricity and abnormal temperature may occur.

- In an atmosphere containing corrosive gas (Cl₂, NH₃, SO_x, NO_x etc.).
- In an atmosphere containing combustible and volatile gases.
- In a dusty environment.
- Direct sunlight
- Water splashing place.
- Humid place where water condenses.
- In a freezing environment.

If there are possibilities for products to be used under the preceding clause, consult with Murata before actual use.

If static electricity is added to this product, degradation and destruction may be produced.

Please use it after consideration enough so that neither static electricity nor excess voltage is added at the time of an assembly and measurement.

If product malfunctions may result in serious damage, including that to human life, sufficient fail-safe measures must be taken, including the following:

- (1) Installation of protection circuits or other protective device to improve system safety
- (2) Installation of redundant circuits in the case of single-circuit failure

7. Input Voltage and Output Current limitation:

Products shall be used in the input power capacity as specified in this specifications.

Inform Murata beforehand, in case that the components are used beyond such input power capacity range won't be achieved.



8. Limitation of Applications:

The products are designed and produced for application in ordinary electronic equipment (AV equipment, OA equipment, telecommunication, etc). If the products are to be used in devices requiring extremely high reliability following the application listed below, you should consult with the Murata staff in advance.

- Aircraft equipment.
- Aerospace equipment
- Undersea equipment.
- Power plant control equipment.
- Medical equipment.
- Transportation equipment (vehicles, trains, ships, etc.).
- Automobile equipment which includes the genuine brand of car manufacture, car factory-installed option and dealer-installed option.
- Traffic signal equipment.
- Disaster prevention / crime prevention equipment.
- Data-procession equipment.
- Application which malfunction or operational error may endanger human life and property of assets.
- Application which related to occurrence the serious damage
- Application of similar complexity and/ or reliability requirements to the applications listed in the above.

Note:

Please make sure that your product has been evaluated and confirmed against your specifications when our product is mounted to your product.

Product specifications are subject to change or our products in it may be discontinued without advance notice.

This catalog is for reference only and not an official product specification document, therefore, please review and approve our official product specification before ordering this product.

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 PTH05T210WAH
 PTH05030WAZ
 V7803-2000R
 PTV12020LAH
 PTN04050CAZT
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